DATA SHEET



BIPOLAR ANALOG INTEGRATED CIRCUIT μ**PC8231TK**

SiGe:C LOW NOISE AMPLIFIER FOR GPS/MOBILE COMMUNICATIONS

DESCRIPTION

The µPC8231TK is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS and mobile communications. This device exhibits low noise figure and high power gain characteristics. This device is enabled in the frequency range from 1.5 to 2.4 GHz by modifying the external matching circuit.

The package is 6-pin lead-less minimold, suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

FEATURES

- Low noise : NF = 0.8 dB TYP. @ fin = 1 575 MHz
- : GP = 20 dB TYP. @ fin = 1 575 MHz High gain : Icc = 3.8 mA TYP. @ Vcc = 3.0 V
- · Low current consumption
- · Built-in power-saving function
- High-density surface mounting : 6-pin lead-less minimold package $(1.5 \times 1.1 \times 0.55 \text{ mm})$
- Included very robust bandgap regulator (Small Vcc and TA dependence)
- · Included protection circuits for ESD

APPLICATION

· Low noise amplifier for GPS and mobile communications

ORDERING INFORMATION

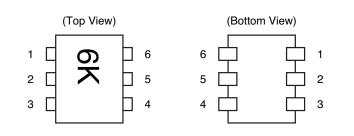
Part I	Number	Order Number	Package	Marking	Supplying Form
μPC823	31TK-E2	μΡC8231TK-E2-A	6-pin lead-less minimold (1511 PKG) (Pb-Free)	6K	 8 mm wide embossed taping Pin 1, 6 face the perforation side of the tape Qty 5 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: µPC8231TK

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

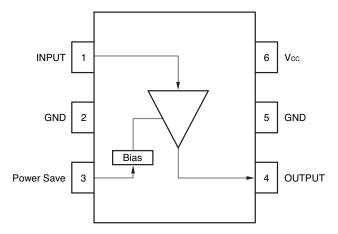
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PIN CONNECTIONS



Pin No.	Pin Name
1	INPUT
2	GND
3	Power Save
4	OUTPUT
5	GND
6	Vcc

INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	TA = +25°C	4.0	V
Power-Saving Voltage	VPS	TA = +25°C	4.0	V
Power Dissipation	PD	T _A = +85°C Note	232	mW
Operating Ambient Temperature	TA		-40 to +85	°C
Storage Temperature	Tstg		-55 to +150	°C
Input Power	Pin		+10	dBm

Note Mounted on double-side copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

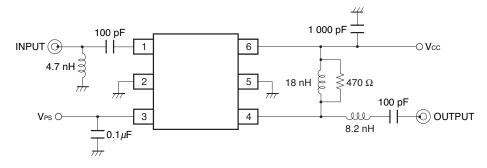
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	2.7	3.0	3.3	V
Operating Ambient Temperature	TA	-40	+25	+85	°C
Power Save Turn-on Voltage	VPSon	1.6	-	Vcc	V
Power Save Turn-off Voltage	VPSoff	0	-	0.4	V

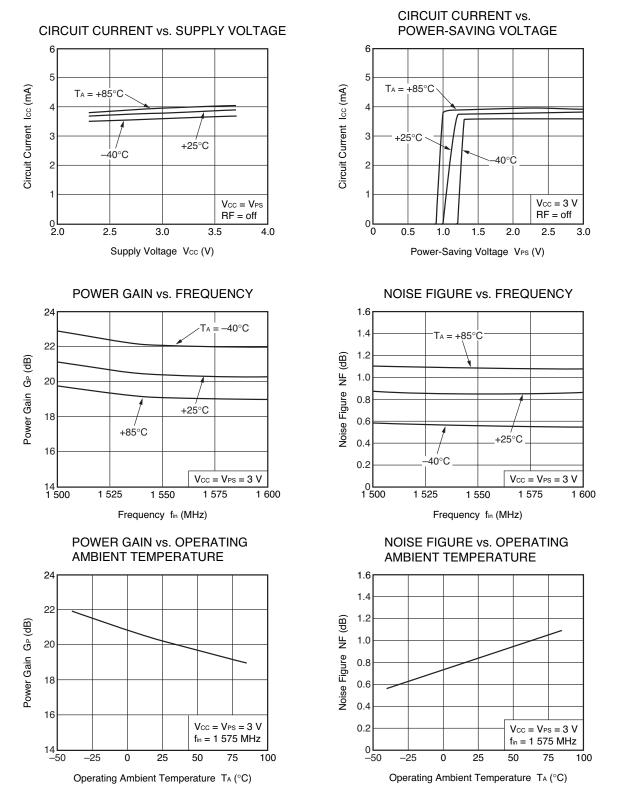
ELECTRICAL CHARACTERISTICS

(TA = +25°C, Vcc = VPs = 3.0 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	lcc	No Signal (VPs = 3.0 V)	2.8	3.8	5.1	mA
		At Power-Saving Mode (VPs = 0 V)	-	-	1	μA
Power Gain	GP	P _{in} = -35 dBm	17.5	20	22.5	dB
Noise Figure	NF		-	0.8	1.1	dB
Input 3rd Order Distortion Intercept Point	IIP3	fin1 = 1 574 MHz, fin2 = 1 575 MHz	-	-10	-	dBm
Input Return Loss	RLin		7	10	-	dB
Output Return Loss	RLout		10	18	-	dB
Isolation	ISL		_	35	_	dB
Gain 1 dB Compression Input Power	Pin (1 dB)		-	-22	-	dBm

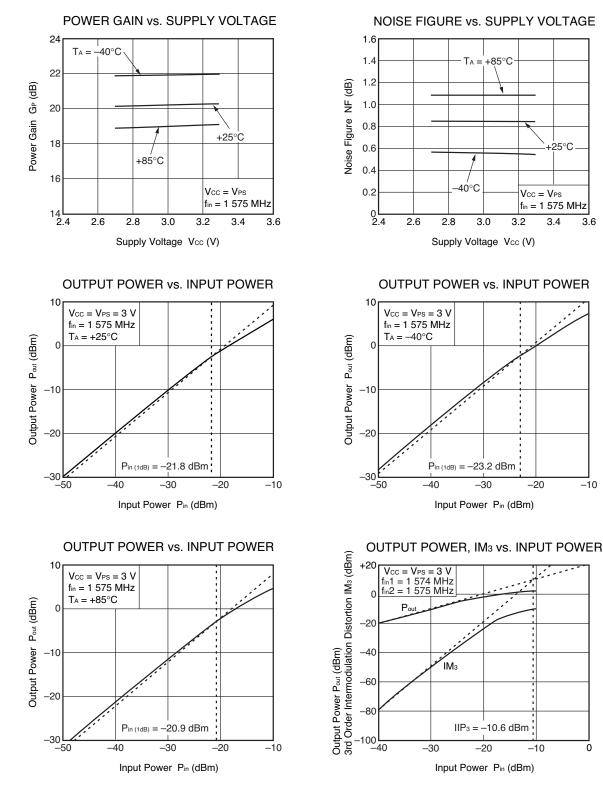
TEST CIRCUIT





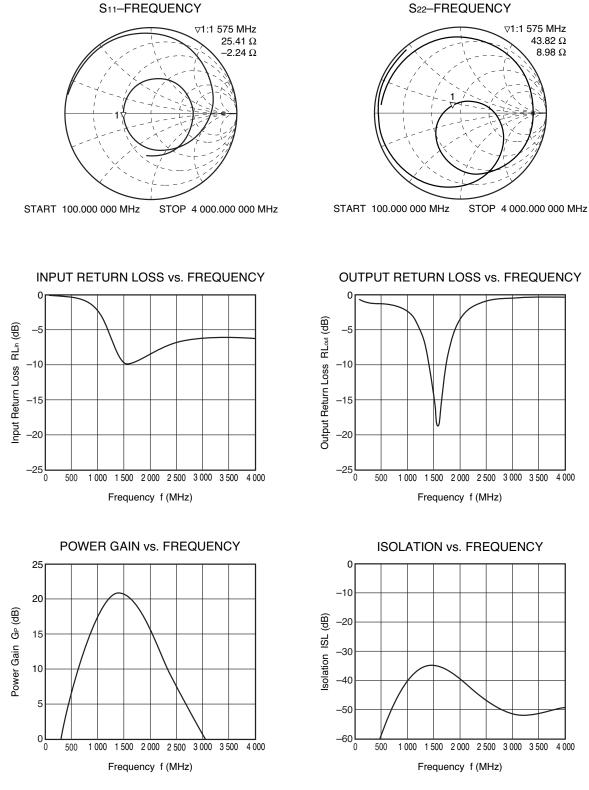
TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

Remark The graphs indicate nominal characteristics.



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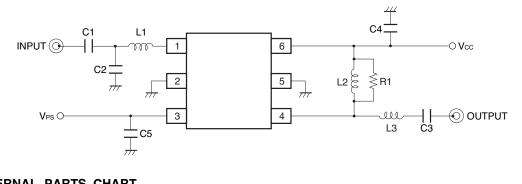
Data Sheet PU10613EJ01V0DS



S-PARAMETERS (TA = +25°C, Vcc = VPs = 3.0 V, monitored at connector on board)

Remark The graphs indicate nominal characteristics.

APPLIED CIRCUIT EXAMPLE



EXTERNAL PARTS CHART

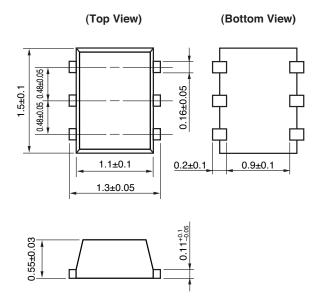
Symbol	Parts	Value				
Symbol	Faits	1.575 GHz Band	1.9 GHz Band	2.14 GHz Band	2.4 GHz Band	Unit
L1	Chip Inductor	5.6	3.9	3.3	2.7	nH
L2	Chip Inductor	18	12	8.2	6.8	nH
L3	Chip Inductor	10	8.2	6.8	5.6	nH
C1	Chip Capacitor	120	5.0	2.0	2.0	pF
C2	Chip Capacitor	1.3	0.7	0.5	0.3	pF
C3	Chip Capacitor	120	5.0	5.0	5.0	pF
C4	Chip Capacitor	1 000	1 000	1 000	1 000	pF
C5	Chip Capacitor	1 000	1 000	1 000	1 000	pF
R1	Chip Resistor	470	470	470	470	Ω

TYPICAL CHARACTERISTICS (TA = +25°C, Vcc = VPs = 3.0 V, unless otherwise specified)

Parameter	Symbol	Reference Value				Unit
Farameter	Symbol	1.575 GHz	1.9 GHz	2.14 GHz	2.4 GHz	Offic
Power Gain	G₽	20.0	19.0	18.0	17.0	dB
Noise Figure	NF	0.78	0.95	1.10	1.27	dB
Input Return Loss	RLin	10.4	10.2	10.2	10.5	dB
Output Return Loss	RLout	21.0	30.0	32.2	23.0	dB

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511 PKG) (UNIT: mm)



NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) Do not supply DC voltage to INPUT pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	H\$350

Caution Do not use different soldering methods together (except for partial heating).



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not De	etected	
РВВ	< 1000 PPM	Not De	etected	
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

See CEL Terms and Conditions for additional clarification of warranties and liability.

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In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.